

SOT232-1

plastic shrink dual in-line package; 32 leads (400 mil)

8 February 2016

Package information

1. Package summary

Terminal position codeD (double)Package type descriptive codeSDIP32

Package type industry code SDIP32
Package style descriptive code SDIP (shrink dual in-line package)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

Mounting method type T (through-hole mount)

Issue date 13-2-2003

Table 1. Package summary

- table in a consign community									
Symbol	Parameter		Min	Тур	Nom	Max	Unit		
D	package length		28.5	-	28.95	29.4	mm		
E	package width		8.7	-	8.9	9.1	mm		
Α	seated height		[tbd]	-	4.7	4.7	mm		
A ₂	package height		[tbd]	-	3.65	3.8	mm		
n ₂	actual quantity of termination		-	-	32	-			



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2. Package outline

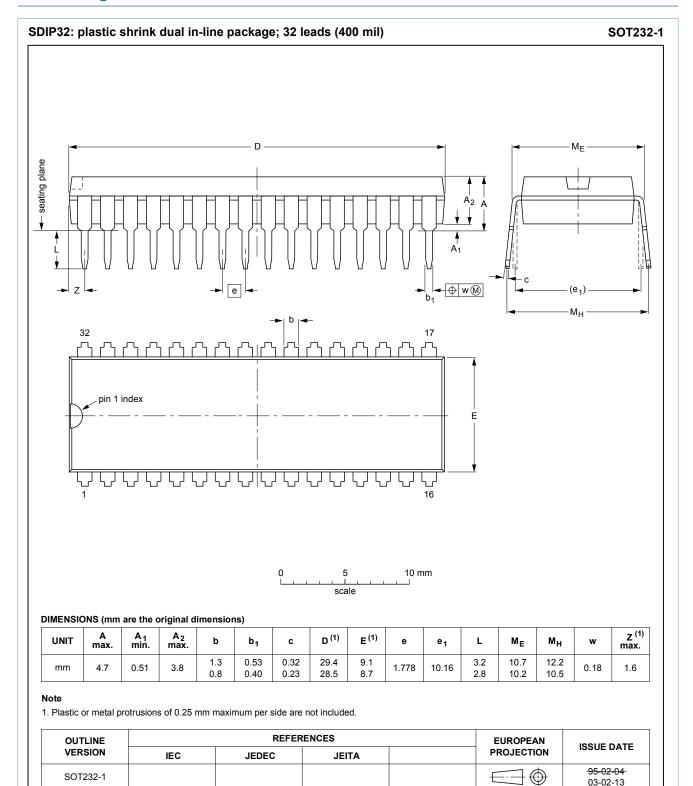


Fig. 1. Package outline SDIP32 (SOT232-1)

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3. Legal information

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4. Contents

1.	Package summary	1
2.	Package outline	2
3.	Legal information	3
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4/4